

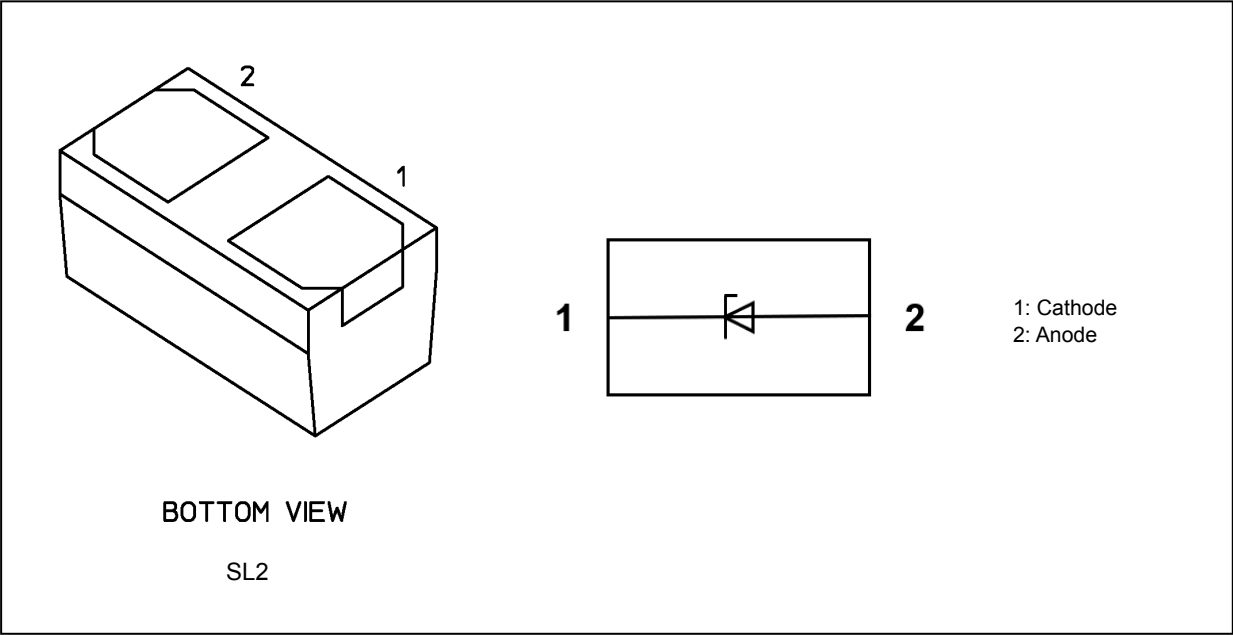
DF2S30ASL

1. Applications

- ESD Protection

Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

2. Packaging and Internal Circuit



3. Absolute Maximum Ratings (Note) (Unless otherwise specified,  $T_a = 25^{\circ}\text{C}$ )

Characteristics	Symbol	Note	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2) (Contact)	$V_{\text{ESD}}$	(Note 1)	$\pm 8$	kV
Electrostatic discharge voltage (IEC61000-4-2) (Air)			$\pm 8$	
Peak pulse power ( $t_p = 8/20 \mu\text{s}$ )	$P_{\text{PK}}$		145	W
Peak pulse current ( $t_p = 8/20 \mu\text{s}$ )	$I_{\text{PP}}$	(Note 2)	2.5	A
Junction temperature	$T_j$		150	$^{\circ}\text{C}$
Storage temperature	$T_{\text{stg}}$		-55 to 150	$^{\circ}\text{C}$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: According to IEC61000-4-2.

Note 2: According to IEC61000-4-5.

Start of commercial production

2022-06

## 4. Electrical Characteristics (Unless otherwise specified, $T_a = 25^\circ\text{C}$ )

$V_{RWM}$ : Working peak reverse voltage  
 $V_Z$ : Zener voltage  
 $V_{BR}$ : Reverse breakdown voltage  
 $Z_Z$ : Dynamic impedance  
 $I_Z$ : Zener current  
 $I_{BR}$ : Reverse breakdown current  
 $I_R$ : Reverse current  
 $V_R$ : Reverse voltage  
 $V_C$ : Clamp voltage  
 $I_{PP}$ : Peak pulse current  
 $R_{DYN}$ : Dynamic resistance  
 $I_F$ : Forward current  
 $V_F$ : Forward voltage

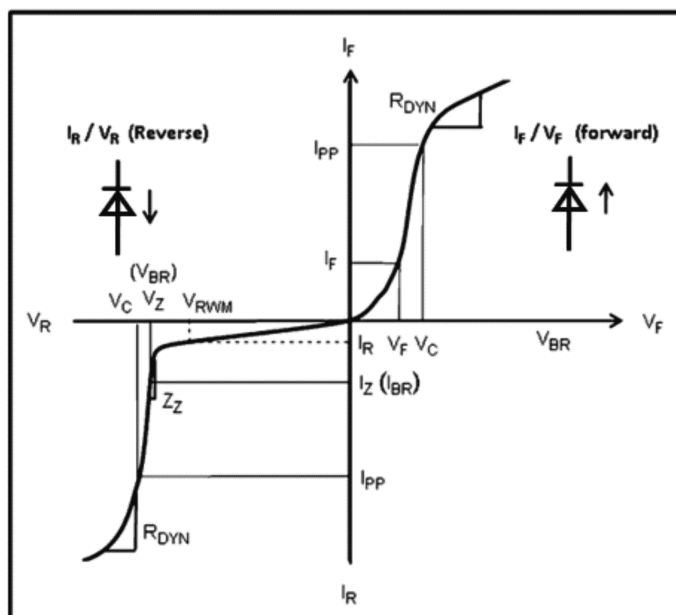


Fig. 4.1 Definitions of Electrical Characteristics

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Working peak reverse voltage	$V_{RWM}$		—	—	—	23	V
Zener voltage (Reverse breakdown voltage)	$V_Z$ ( $V_{BR}$ )		$I_Z = 2\text{ mA}$ ( $I_{BR} = 2\text{ mA}$ )	28.0	30.0	32.0	V
Dynamic impedance	$Z_Z$		$I_Z = 2\text{ mA}$ ( $I_{BR} = 2\text{ mA}$ )	—	—	150	$\Omega$
Reverse current	$I_R$		$V_{RWM} = 23\text{ V}$	—	—	0.5	$\mu\text{A}$
Clamp voltage	$V_C$	(Note 1)	$I_{PP} = 1\text{ A}$	—	38.2	—	V
			$I_{PP} = 2.5\text{ A}$	—	49.2	58	
		(Note 2)	$I_{TLP} = 8\text{ A}$	—	51	—	V
			$I_{TLP} = 16\text{ A}$	—	84.5	—	
Dynamic resistance	$R_{DYN}$	(Note 2)	—	—	4	—	$\Omega$
Total capacitance	$C_t$	(Note 3)	$V_R = 0\text{ V}$ , $f = 1\text{ MHz}$	—	7.5	—	pF

Note 1: Based on IEC61000-4-5 8/20  $\mu\text{s}$  pulse.

Note 2: TLP parameter:  $Z_0 = 50\ \Omega$ ,  $t_p = 100\text{ ns}$ ,  $t_r = 300\text{ ps}$ , averaging window:  $t = 30\text{ ns}$  to  $60\text{ ns}$ , extraction of dynamic resistance using a least-squares fit of TLP characteristics at  $I_{PP}$  between 8 A to 16 A.

Note 3: Guaranteed by design.

## 5. Marking

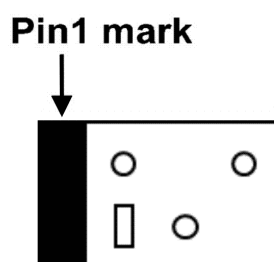


Fig. 5.1 Marking

## 6. Land Pattern Dimensions (for reference only)

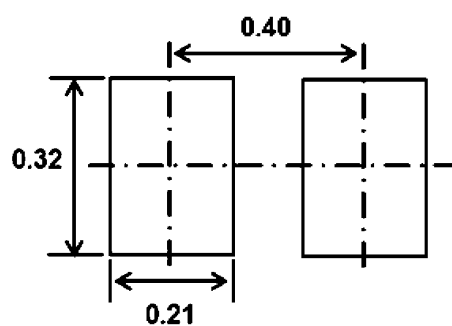


Fig. 6.1 Land Pattern Dimensions (Unit: mm)

7. Characteristics Curves (Note)

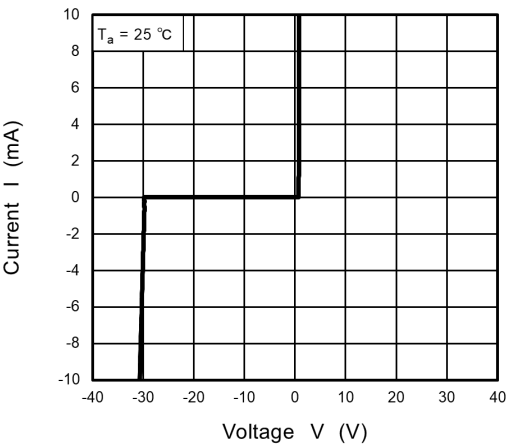


Fig. 7.1 I - V

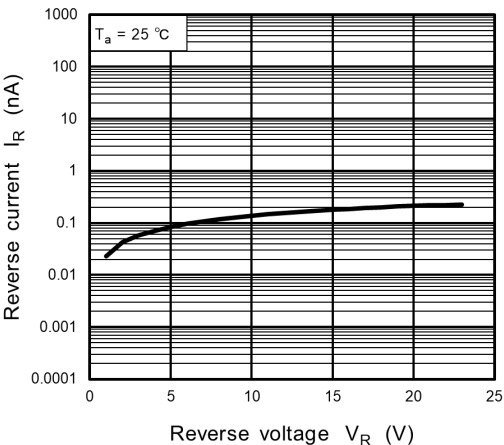


Fig. 7.2  $I_R$  -  $V_R$

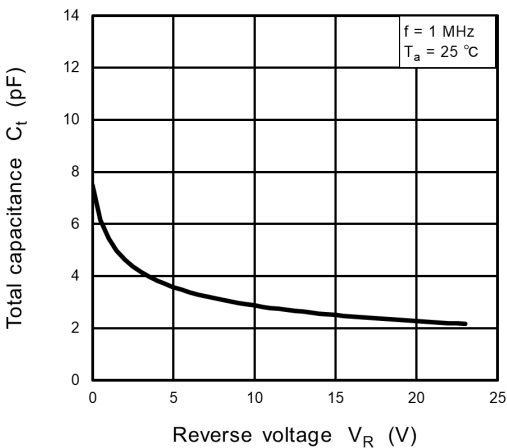


Fig. 7.3  $C_t$  -  $V_R$

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

8. Clamp Voltage - Peak Pulse Current ( $V_C$  -  $I_{PP}$ ) (Note)

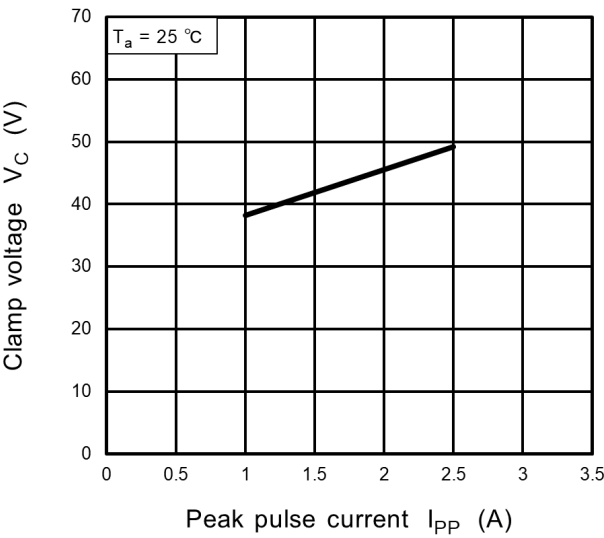


Fig. 8.1  $V_C$  -  $I_{PP}$

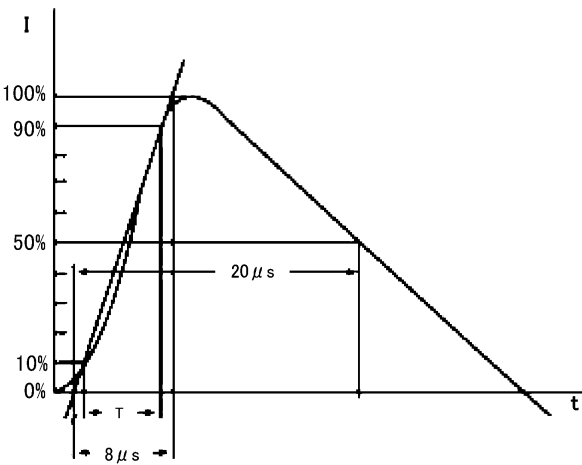


Fig. 8.2 Based on IEC61000-4-5 8/20  $\mu\text{s}$  pulse.(Ed.2)

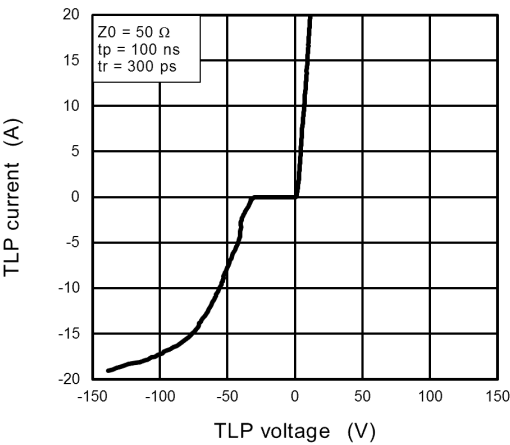


Fig. 8.3 TLP

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

9. ESD Clamp Waveform (Note)

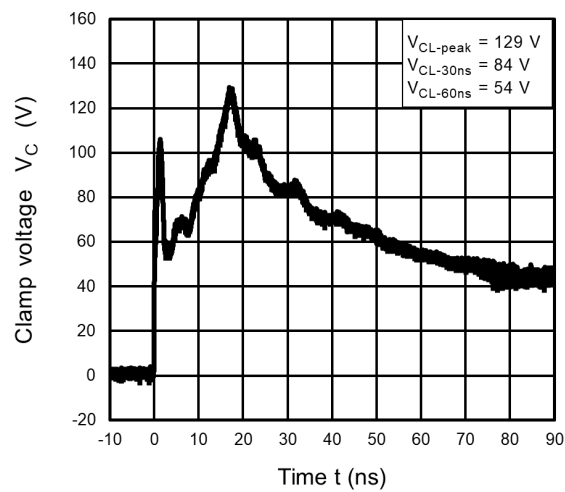


Fig. 9.1 +8 kV

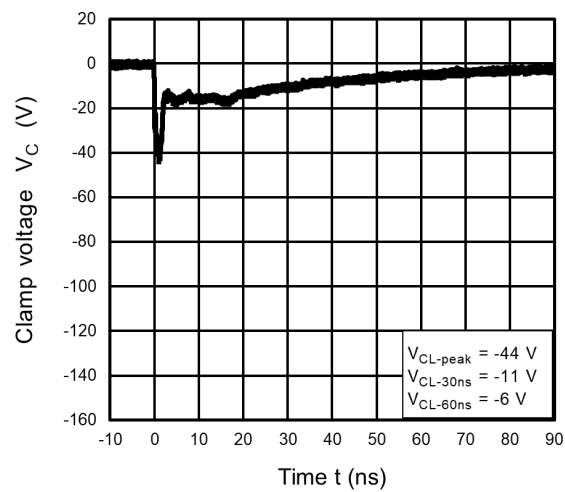


Fig. 9.2 -8 kV

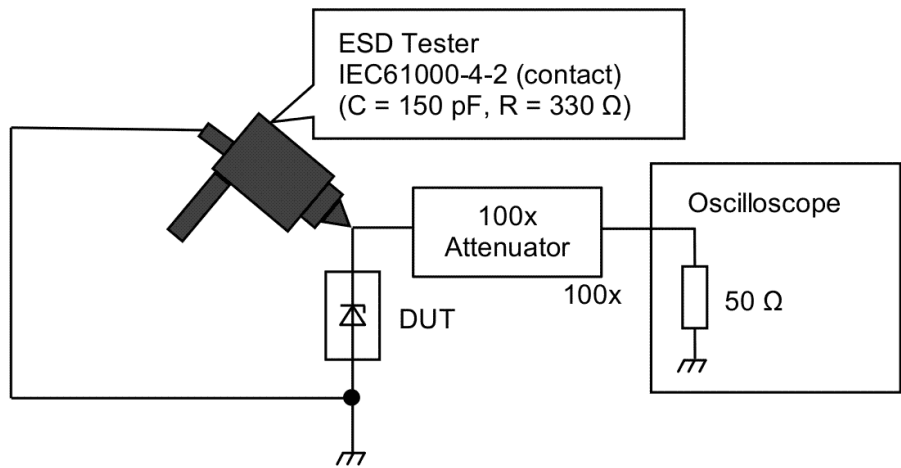
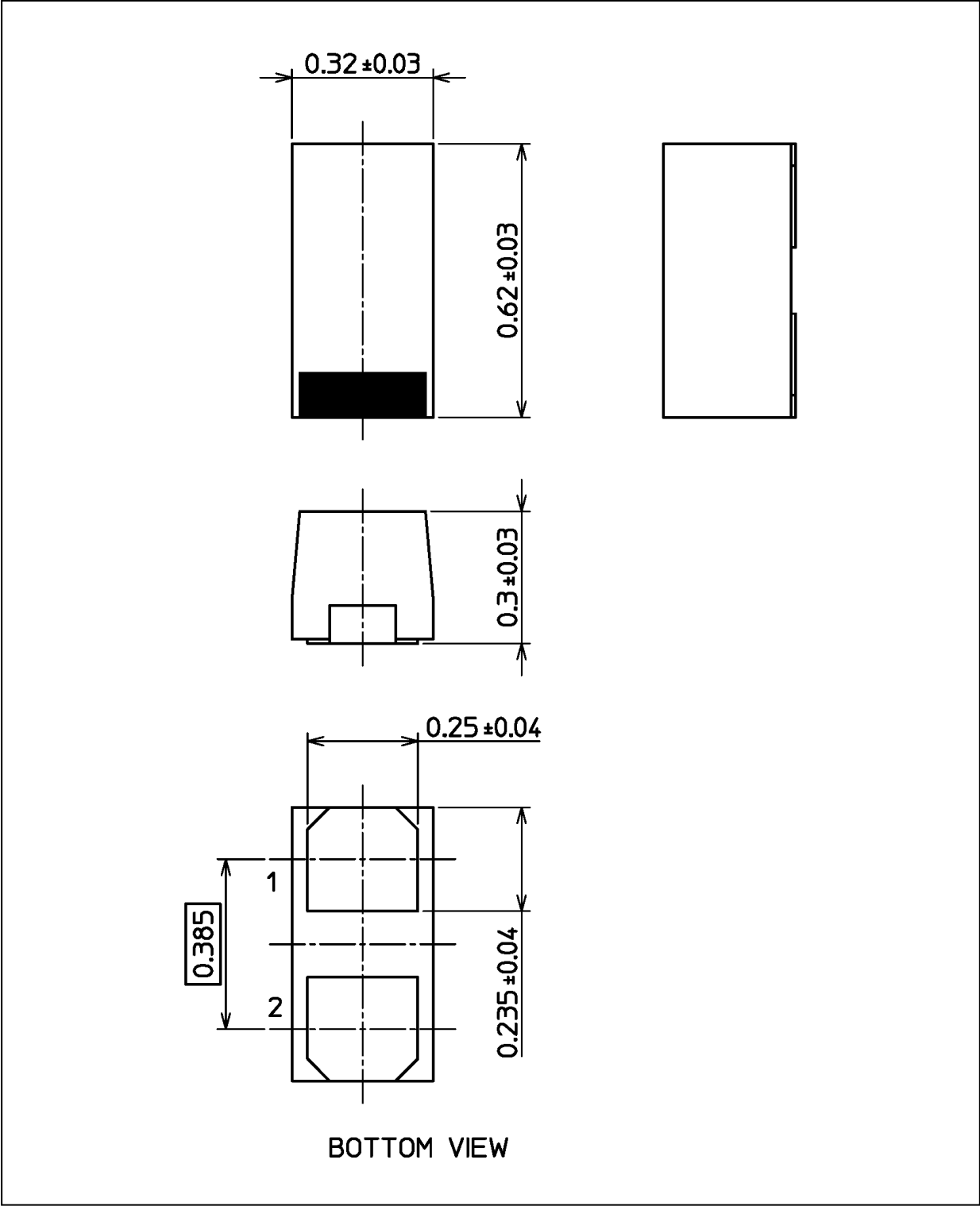


Fig. 9.3 IEC61000-4-2 (Contact)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.2 mg (typ.)

Package Name(s)
Nickname: SL2

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